



TO-3PF Plastic-Encapsulate Diode

MURPF30H60A HYPERFAST RECTIFIER,FRED

MAIN CHARACTERISTICS

I_o	30A
V_{RRM}	600V
T_{rr}	20ns
T_j	175°C
$V_{F(typ)}$	1.5V(@$T_j=150^\circ\text{C}$)

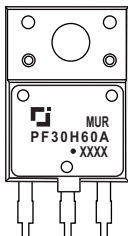
FEATURES

- Ultrafast Recovery Times and Low Recovery Loss
- Low Forward Voltage
- Low Reverse Leakage Current

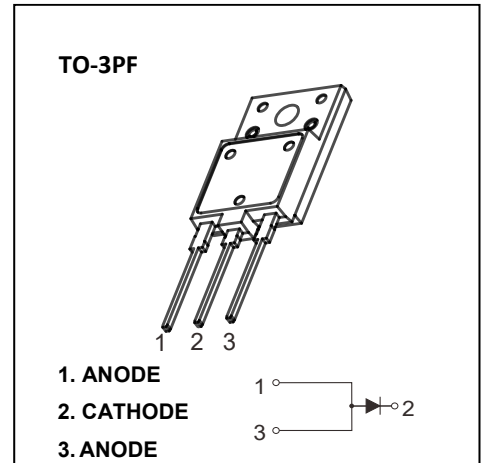
APPLICATIONS

Specifically designed to improve efficiency of PFC and output rectification stages of EV / HEV battery charging stations, booster stage of solar inverters and UPS applications, these devices are perfectly matched to operate with MOSFETs or high speed IGBTs.

MARKING



MURPF30H60A = Device code
 Solid dot = Green molding compound device
 if none, the normal device
 XXXX = Code



MAXIMUM RATINGS ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	MURPF30H60A	Unit
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V_R	DC Blocking Voltage		
$I_{F(AV)}$	Average rectified output current($T_c=110^\circ\text{C}$)	30	A
$I_{F(RMS)}$	RMS Forward Current($T_c=110^\circ\text{C}$)	21	A
I_{FSM}	Non-Repetitive Surge Forward Current (8.3ms)	200	A
P_D	Power dissipation	167	W
$R_{\theta JC}$	Thermal Resistance From Junction to Case@ Per leg	0.9	$^\circ\text{C}/\text{W}$
T_j	Operating Junction Temperature Range	-55 ~ +175	$^\circ\text{C}$
T_{stg}	Storage Temperature Range	-55 ~ +175	$^\circ\text{C}$

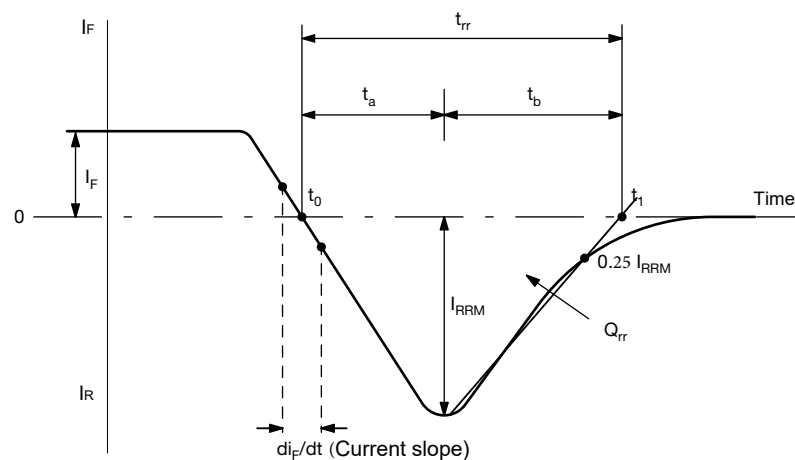
Typical Characteristics

ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$V_{(BR)}$	Reverse Voltage	$I_R=100\mu\text{A}$	600			V
I_R	Reverse Current	$V_R=600\text{V}$	$T_j=25^\circ\text{C}$		1	μA
			$T_j=150^\circ\text{C}$		500	μA
V_F	Forward Voltage	$I_F=30\text{A}$	$T_j=25^\circ\text{C}$	2.3	2.6	V
			$T_j=150^\circ\text{C}$	1.5		V
C_{tot}	Total Capacitance	$V_R=200\text{V}, f=1\text{MHz}$		50		pF
t_{rr}	Reverse Recovery time	$I_F=0.5\text{A}, I_R=1\text{A}, I_{rr}=0.25\text{A}$		25		ns
		$I_F=1\text{A}, V_R=30\text{V}, di_F/dt = 200\text{A/us}$		20		ns

ELECTRICAL CHARACTERISTICS ($T_c=25^\circ\text{C}$ unless otherwise specified)

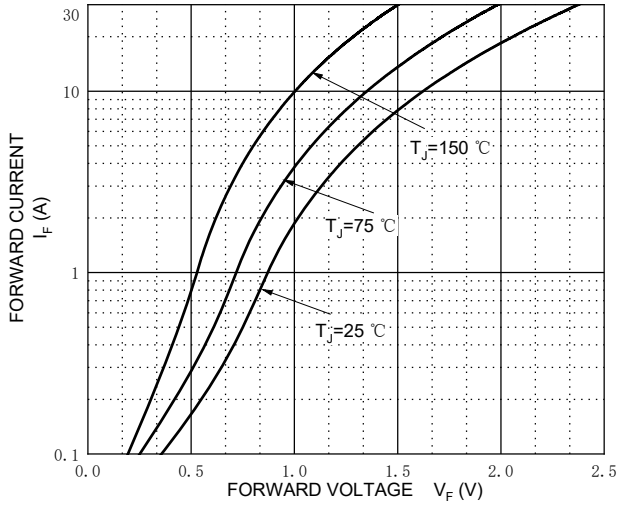
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
t_{rr}	Reverse Recovery Time	$I_F=30\text{A}, V_R=400\text{V}, di_F/dt=200\text{A}/\mu\text{s}$		28		ns
I_{RRM}	Max. Reverse Recovery Current			2		A
Q_{rr}	Reverse Recovery Charge			28		nC
t_{rr}	Reverse Recovery Time	$I_F=30\text{A}, V_R=400\text{V}, di_F/dt=200\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		70		ns
I_{RRM}	Max. Reverse Recovery Current			6		A
Q_{rr}	Reverse Recovery Charge			230		nC
t_{rr}	Reverse Recovery Time	$I_F=30\text{A}, V_R=400\text{V}, di_F/dt=600\text{A}/\mu\text{s}, T_j=125^\circ\text{C}$		43		ns
I_{RRM}	Max. Reverse Recovery Current			18		A
Q_{rr}	Reverse Recovery Charge			415		nC



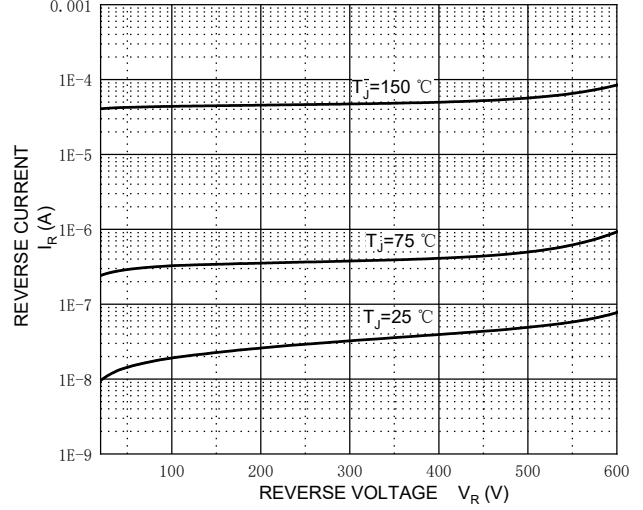
Reverse Recovery Waveform and Definitions

Typical Characteristics

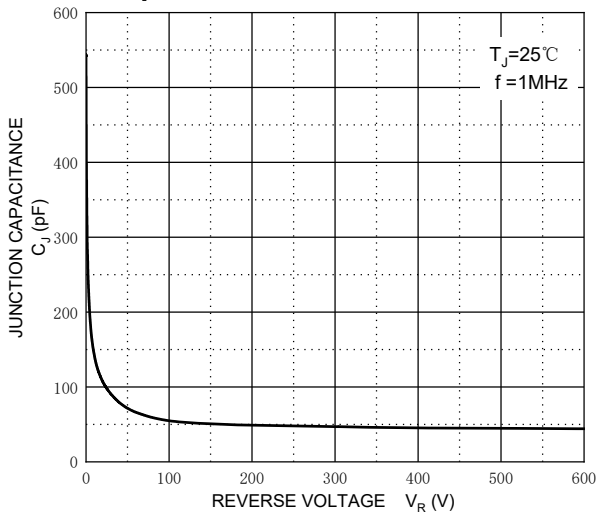
Forward Characteristics



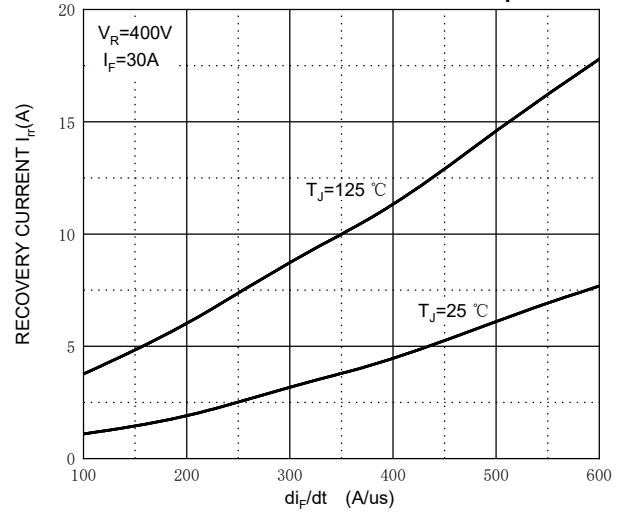
Reverse Characteristics



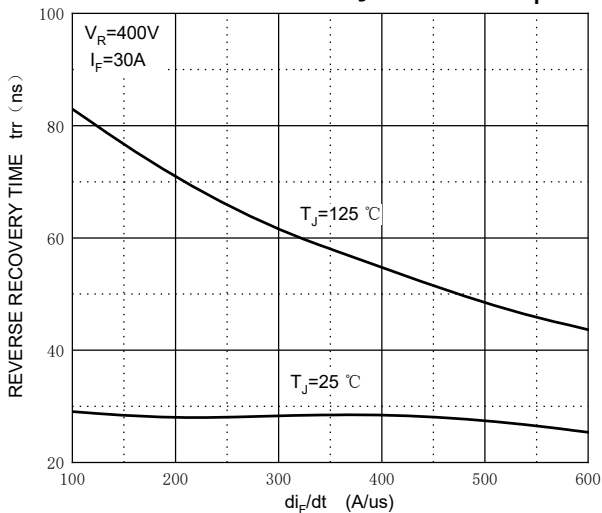
Capacitance Characteristics Per Diode



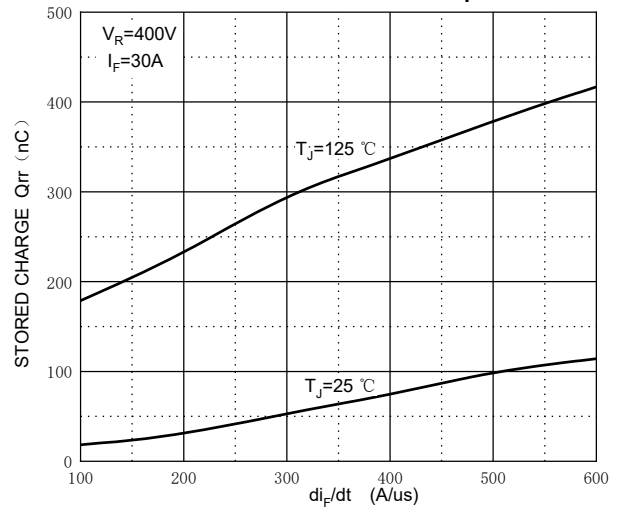
Recovery Current vs. di_F/dt



Reverse Recovery Time vs. di_F/dt

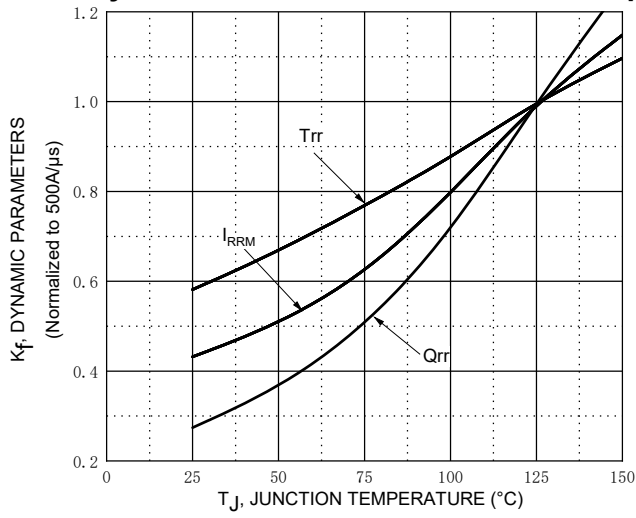


Stored Charge vs. di_F/dt

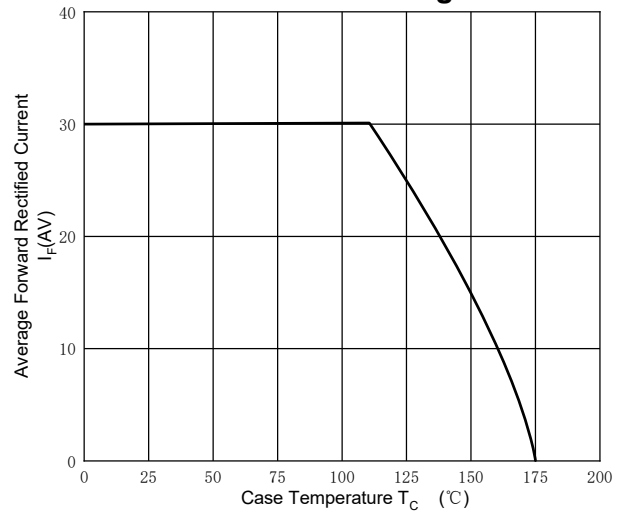


Typical Characteristics

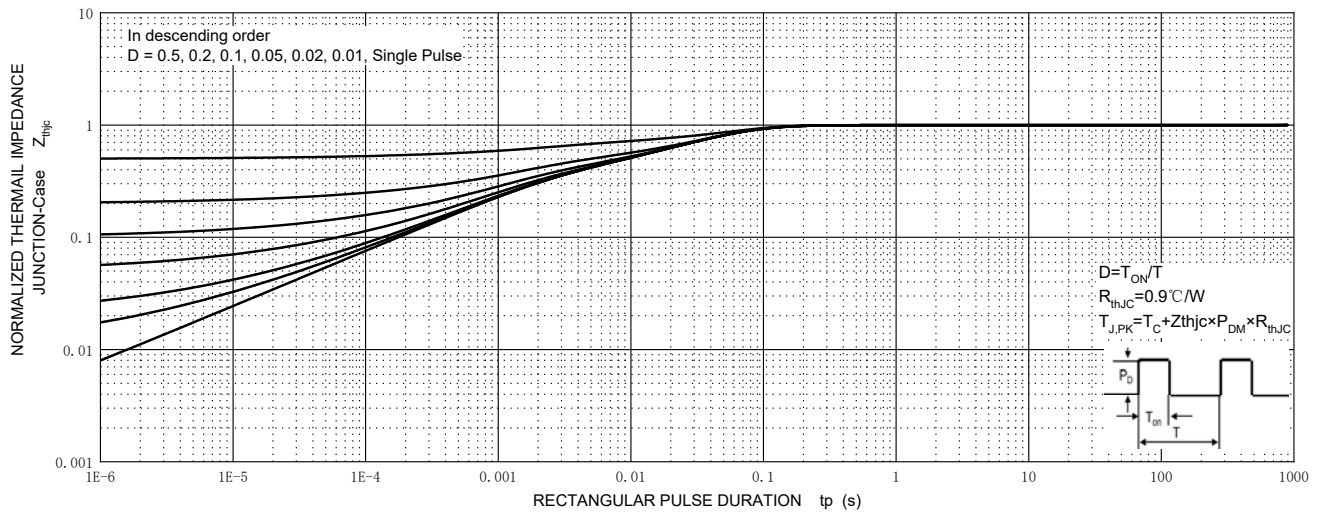
Dynamic Parameters vs. Junction Temperature



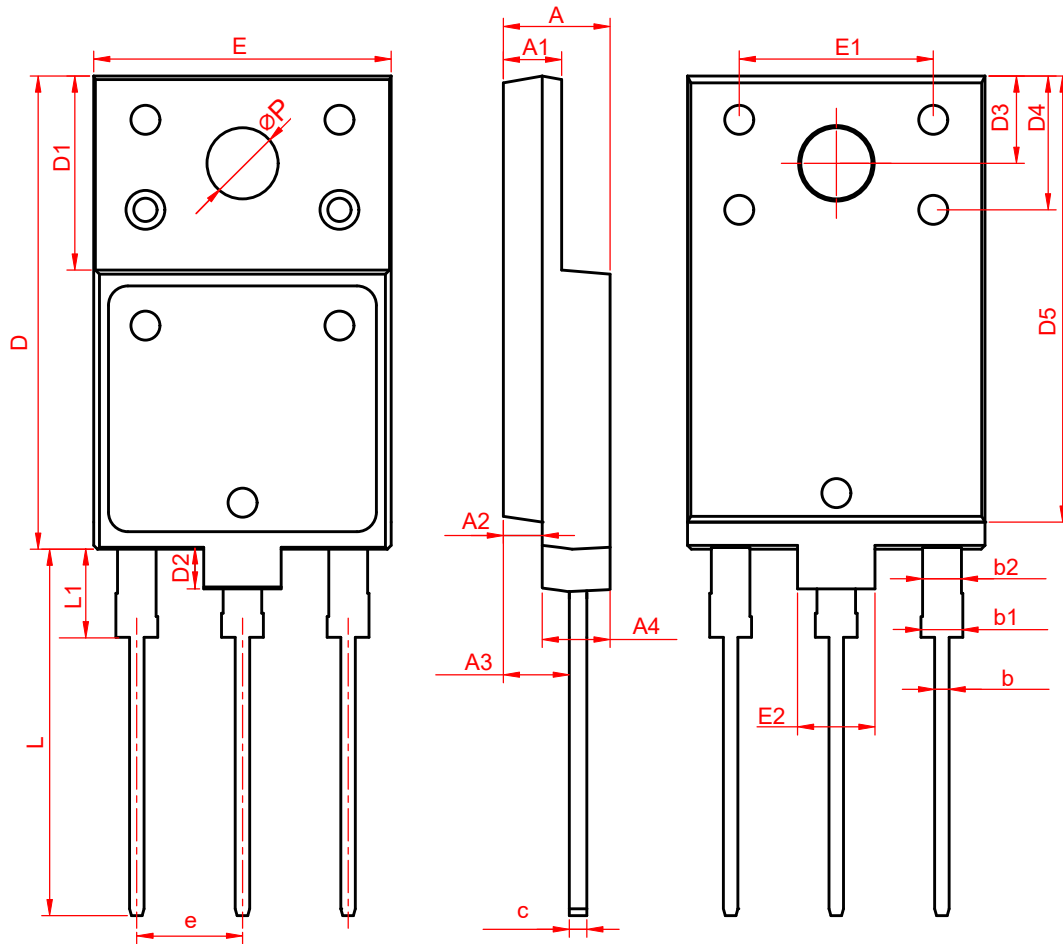
Current Derating



MURPF30H60A Transient Thermal Impedance, Junction-Case



TO-3PF Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	5.30	5.70	0.209	0.224
A1	2.80	3.20	0.110	0.126
A2	1.85	2.15	0.073	0.085
A3	3.30	3.50	0.130	0.138
A4	3.35	3.65	0.132	0.144
b	0.68	0.83	0.027	0.033
b1	2.06	2.26	0.081	0.089
b2	1.92	2.08	0.076	0.082
c	0.82	0.98	0.032	0.039
D	24.20	24.60	0.953	0.969
D1	9.80	10.20	0.386	0.402
D2	1.85	2.25	0.073	0.089
D3	4.35	4.65	0.171	0.183
D4	6.70	7.10	0.264	0.280
D5	22.75	23.25	0.896	0.915
e	5.45 BSC		0.215 BSC	
E	15.15	15.55	0.596	0.612
E1	9.75	10.25	0.384	0.404
E2	3.85	4.15	0.152	0.163
L	18.70	19.10	0.736	0.752
L1	4.40	4.70	0.173	0.185
ΦP	3.57	3.77	0.141	0.148